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(12) **United States Design Patent**
Chen

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(54) **ARM FOR HEADPHONE**

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(*) Notice: This patent is subject to a terminal disclaimer.

(**) Term: **15 Years**

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(51) **LOC (14) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/205; D14/217**

(58) **Field of Classification Search**
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381/380, 370, 74, 374, 183, 377, 378;
455/90.3, 575.1, 569.1
CPC H04R 25/00; H04R 25/02; H04R 1/1016;
H04R 1/1066; H04R 5/033; H04R
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H04R 1/1091; A43C 11/1406
See application file for complete search history.

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Primary Examiner — Paula Allen Greene

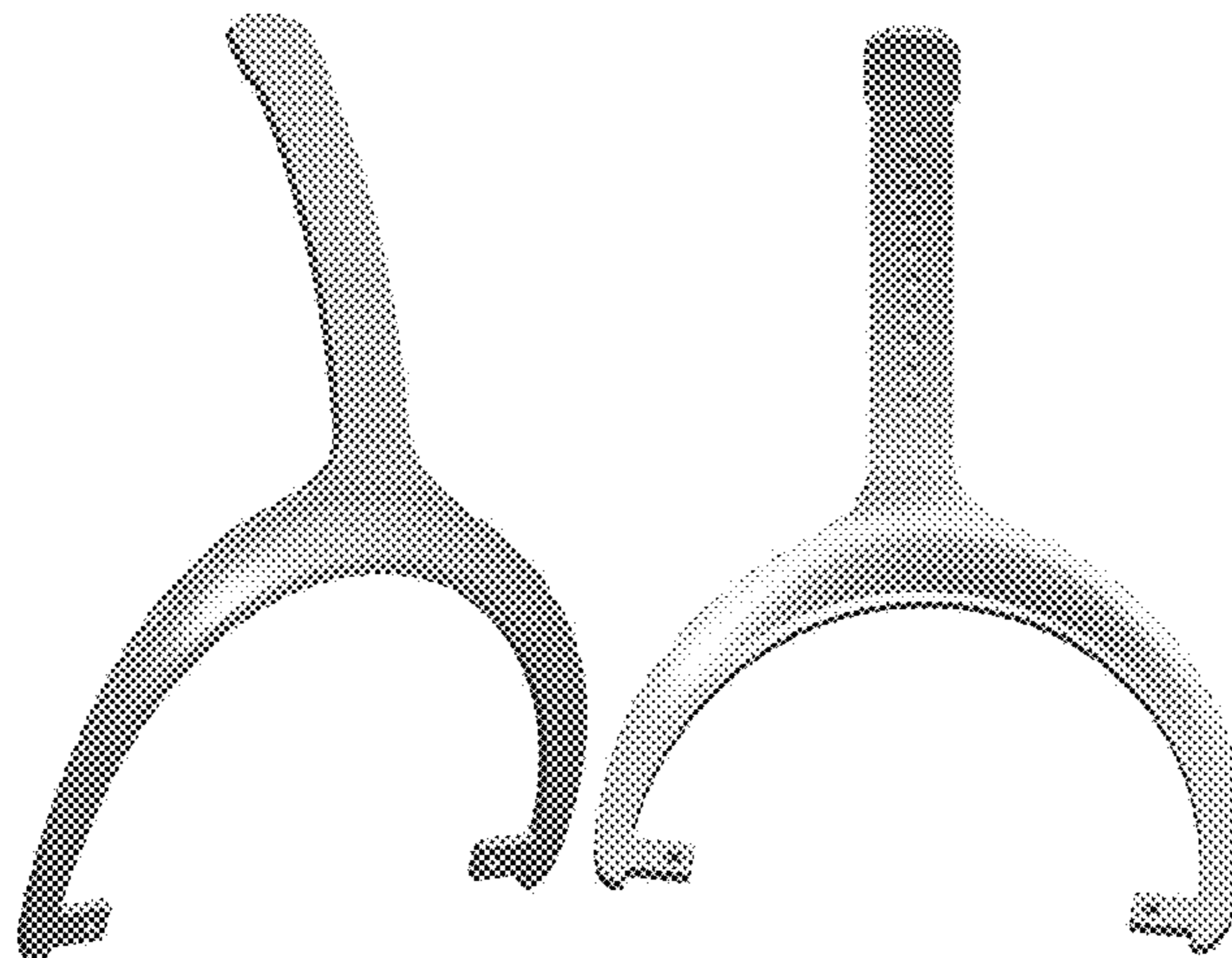
(57) **CLAIM**

I claim an ornamental design for an arm for a headphone, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of an arm for headphone showing my new design;
FIG. 2 is a second perspective view of FIG. 1;
FIG. 3 is a third perspective view of FIG. 1;
FIG. 4 is a front elevational view of FIG. 1;
FIG. 5 is a rear elevational view of FIG. 1;
FIG. 6 is a left side elevational view of FIG. 1;
FIG. 7 is a right side elevational view of FIG. 1;
FIG. 8 is a top plan view of FIG. 1;
FIG. 9 is a bottom plan view of FIG. 1; and,
FIG. 10 is a perspective reference view thereof; the broken lines of the headphone form no part of the claimed design. The headphone shown as transparent in FIG. 10 represents environment and is provided for illustrative purpose only and forms no part of the claimed design.

(Continued)



The broken lines depict environment that forms no part of the claimed design.

1 Claim, 10 Drawing Sheets

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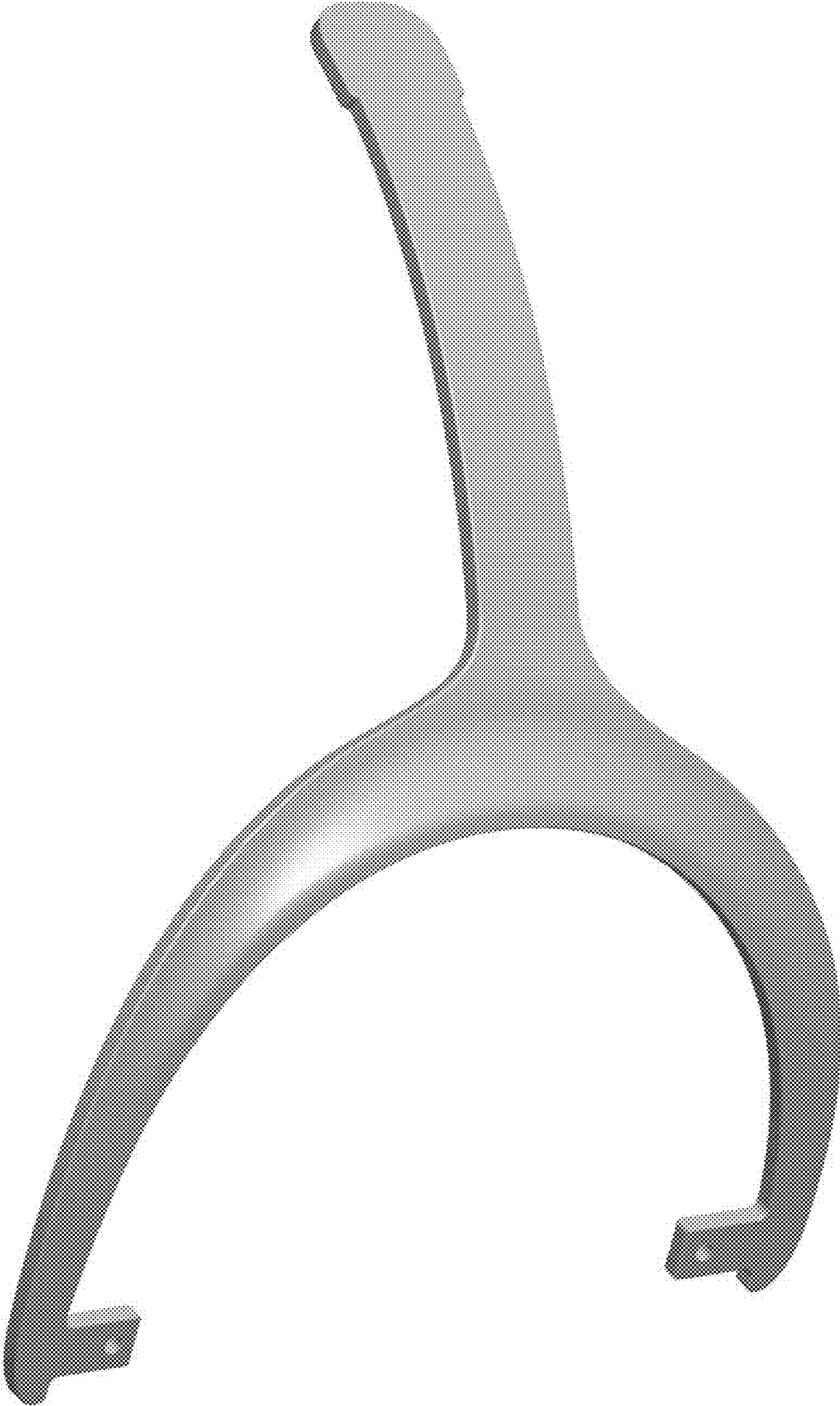


FIG. 1



FIG. 2



FIG. 3



FIG. 4



FIG. 5

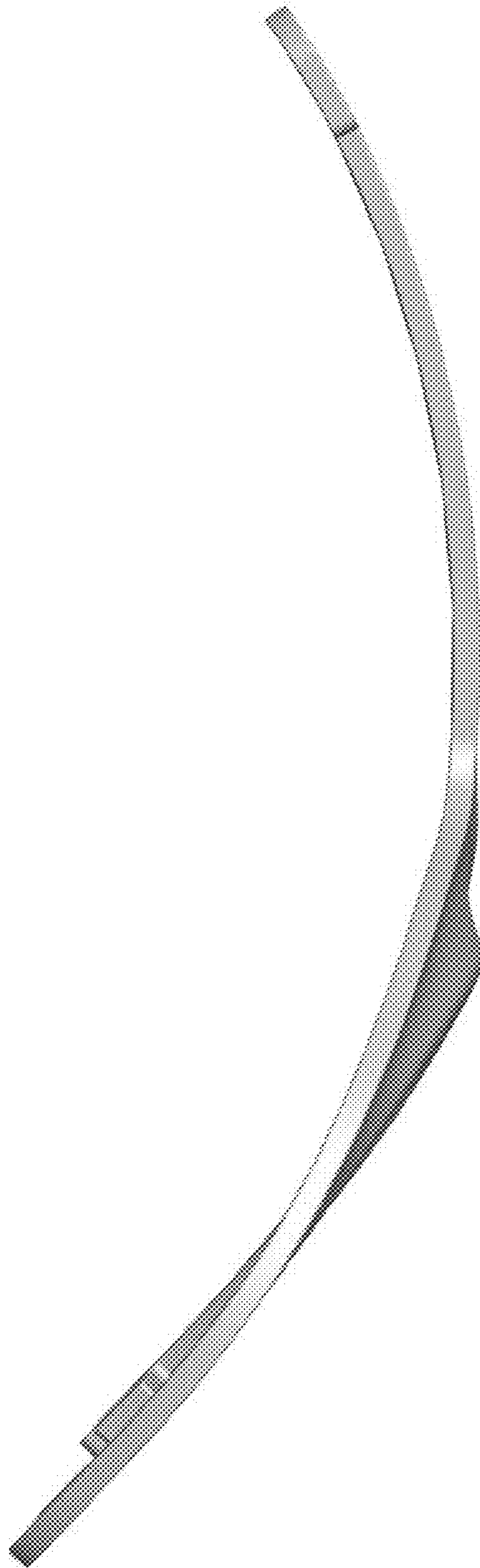


FIG. 6

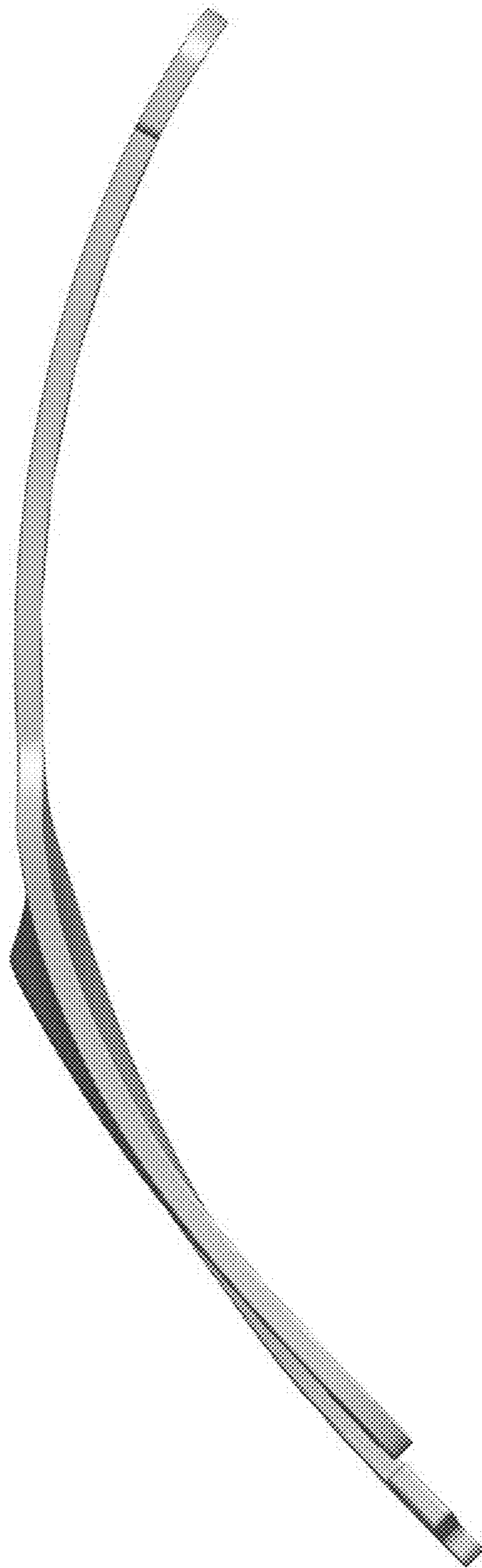


FIG. 7

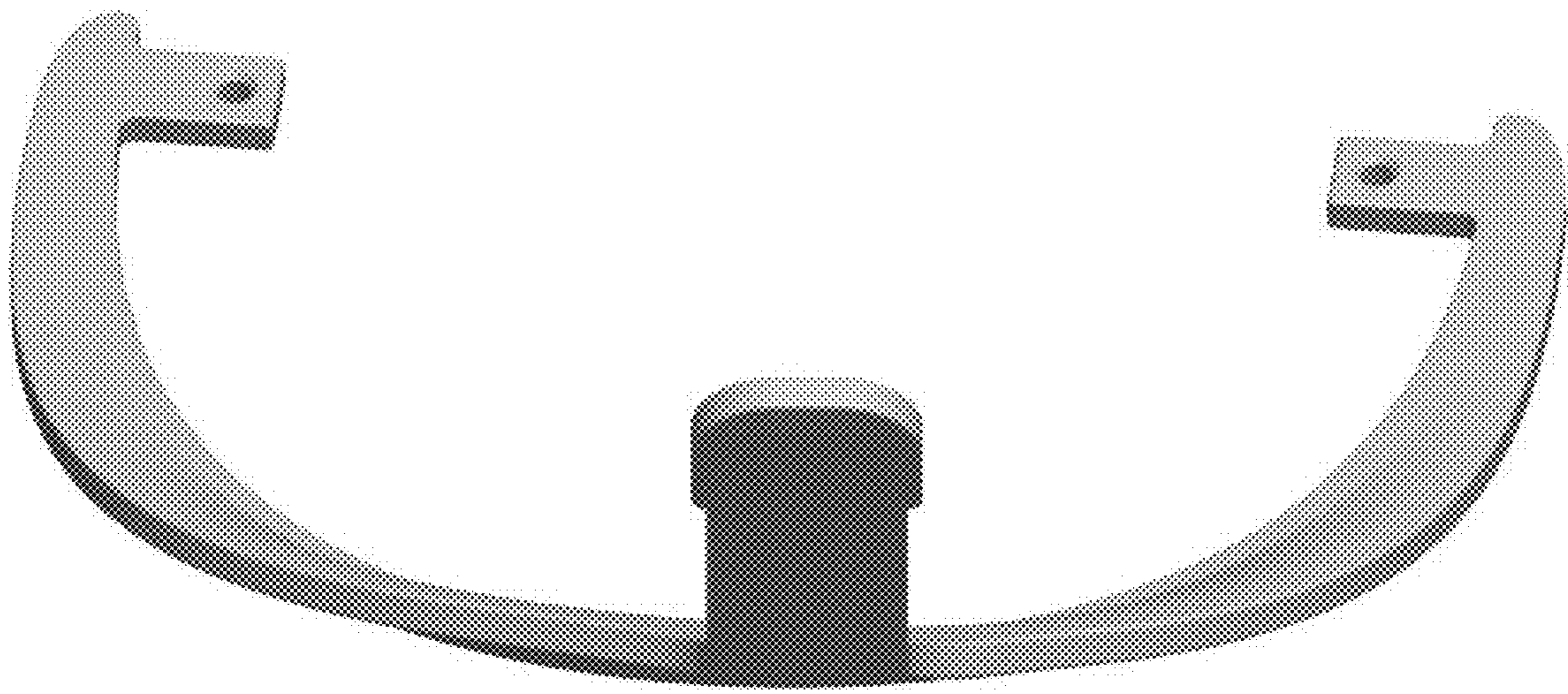


FIG. 8

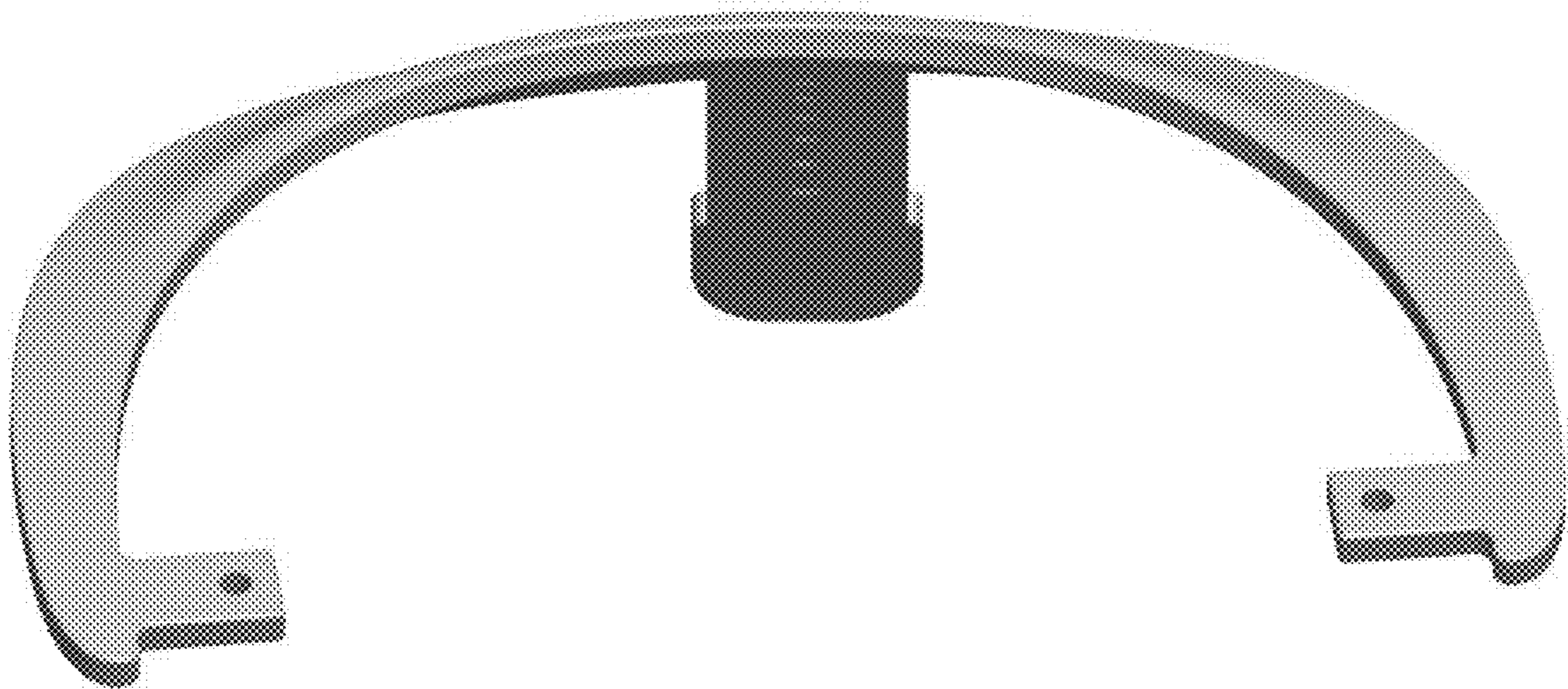


FIG. 9

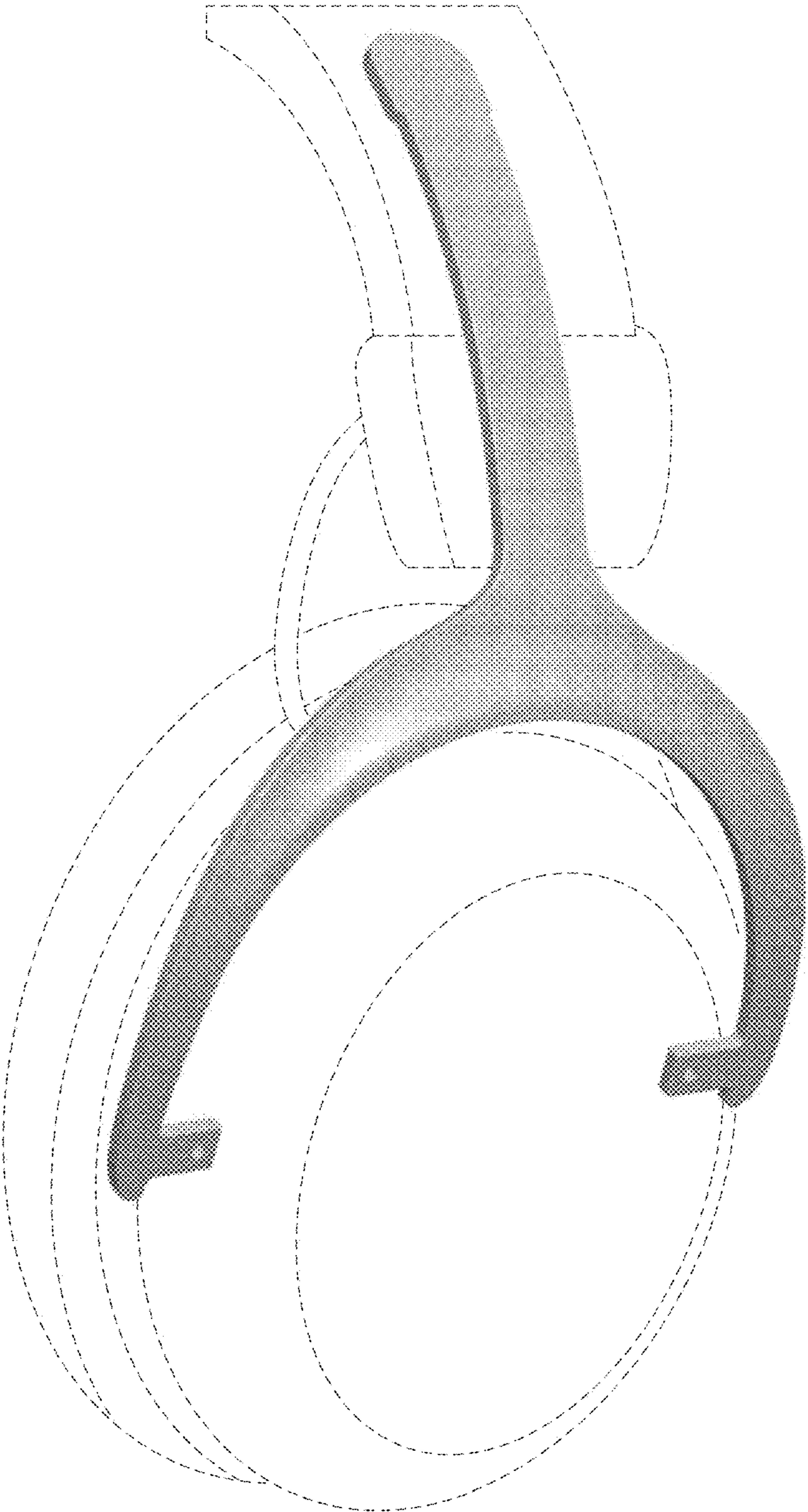


FIG. 10